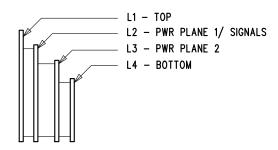
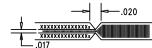
REVISION HISTORY						
EC0	REV	DESCRIPTION	APP. ENG.	DATE		
-	1	REBUILD WITH CHANGE	KAUGH H.	10-06-15		

LAYER STRUCTURE

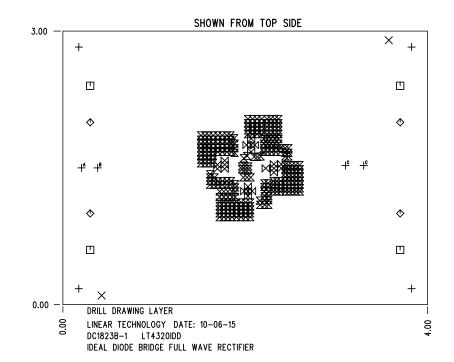


NOTES: UNLESS OTHERWISE SPECIFIED

- 1. FAB PER IPC-A-600.
- 2. MATERIAL: -LEAD FREE ASSEMBLY COMPLIANT, ISOLA FR-370HR OR EQUIVALENT.
 - -FINISHED THICKNESS TO BE 0.062 +/- .005
 - -TOTAL OF 4 LAYERS WITH 2 OZ. CU ON THE OUTER LAYERS AND 2 OZ. CU ON THE INNER LAYERS.
 - -FLAMMABILITY RATING: 94 V-O MINIMUM.
- 3. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN. 0/0 ARE PRIMARY DATUMS.
- 4. DRILLING: -DRILL HOLES PER SCHEDULE. PLATE THROUGH HOLES WITH COPPER, 0.001 THICK MIN.
 - -ALL HOLE SIZES ARE SPECIFIED AFTER PLATING.
 - -HOLE LOCATION TOLERANCES ARE +/-0.003 IN RELATION TO CENTER
- 5. FINISH: -SMOBC USING LPI BOTH SIDES, COLOR GREEN.
 - -GOLD IMMERSION BOTH SIDES.
 - -FOR SILKSCREENS: USE WHITE NON-CONDUCTIVE INK.
- 6. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE. PAD SIZE CAN BE MODIFIED TO MEET END FINISH.
- 7. PCBS ARE TO BE RoHS COMPLIANT.
- 8. SCORING FOR PANELIZED PCB:



UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES	APPROVALS			T	LINEAR		A 95035 2-1900
TOLERANCES: $XX = \pm 0.01$	PCB DES.	KIM T.		_/	TECHNOLOGY	LTC CONFID FOR CUSTO	
$XXX = \frac{1}{2} 0.005$	APP ENG.	KAUGH H.	TITLE:	FABRICA	TION DRAWING		
INTERPRET DIM AND TOL PER ASME Y14.5M-1994 THIRD ANGLE PROJECTION			IDEAL	DIODE	BRIDGE FULL W	AVE REC	TIFIER
				IC NO.	LT4320IDD		REV
			N/A		DEMO CIRCUIT 1	823B	11
Τ -	SCALE :	= NONE	FILENA	ME: DC	1823B-1.PCB	SH	T 1 0F 1



SIZE	QTY	SYM	PLATED	TOL
0.19	4	+	NO	+/-0.003"
0.07	2	X	NO	+/-0.003"
0.205	4		YES	+/-0.003"
0.094	4	♦	YES	+/-0.003"
0.012	269	X	YES	+/-0.003"
0.008	21	\bowtie	YES	+/-0.003"
0.065	1	+	NO	+/-0.003"
0.072	1	+B	NO	+/-0.003"
0.035	2	+c	YES	+/-0.003"